

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Atmel Switzerland Sarl	09/19/2008
RECEIVING PARTY DATA	
Name:	AuthenTec, Inc.
Street Address:	100 Rialto Place
Internal Address:	Ste. 100
City:	Melbourne
State/Country:	FLORIDA
Postal Code:	32901
PROPERTY NUMBERS Total: 2	
Property Type	Number
Patent Number:	6289114
Patent Number:	6459804
CORRESPONDENCE DATA	
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ATTORNEY DOCKET NUMBER:	51701, 51701_CON1 (4)
NAME OF SUBMITTER:	Christopher F. Regan
Total Attachments: 5	

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ANNEX C

CONFIRMATION OF ASSIGNMENT

Between Atmel Switzerland Sarl, a corporation existing under the laws of Switzerland, having a principal place of business at Route des Arsenaux 41 BP 80 CH-1705 Fribourg Switzerland ("Assignor"), and

AuthenTec, Inc., a corporation existing under the laws of Delaware, having a principal place of business at 100 Rialto Place, Suite 400, Melbourne, Florida 32901 ("Assignee");

WHEREAS Assignor and Assignee have signed a certain agreement on September 5, 2008 relative to the assignment of property rights and desire to confirm this assignment in order to simplify registration formalities with the patent offices in the jurisdictions in which such patents have issued or where such patent applications are pending.

SINGLE ARTICLE

Assignor hereby confirms the assignment of its entire right, title and interest in the patents and patent applications listed on Exhibit A from Assignor to Assignee with the effective date of September 5, 2008.

In addition, Assignor hereby authorizes and respectfully requests the U.S. Commissioner of Patents and Trademarks at the U.S. Patent and Trademark Office, and any officer of equivalent position within the patent office of any foreign jurisdiction to record this assignment for issued patents; and to issue in the name of Assignee (or its lawful successors and assigns) all forthcoming patents for any invention that is the subject of the patent applications on Exhibit A.

IN TESTIMONY WHEREOF, each party has caused its authorized representative to execute this Confirmation of Assignment.

ASSIGNOR

By: P. Reutens
Name: Patrick Reutens
Title: Director
Date: 9/19/2008

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Exhibit A

Assigned Patents and Patent Applications

PATENT LIST - TRANSFER
 Armin Schweizer

Exhibit A

Patent No.	Title	Country	Type	Filing date	Filing number	Grant date	Grant number	Status
1	SYSTEM AND METHOD FOR READING FINGERPRINTS (Title per public database: Fingerprint-reading system or SYSTEME DE LECTURE D'EMPREINTES DIGITALE)	AR	BN	12-Jun-97	970102568	27-Nov-02	AF00756481	Granted
2	ABSTRACT: A fingerprint-reading system includes a fingerprint sensor having an active surface sensitive to the pressure and a temperature of a finger. The surface area of the sensor is smaller than the surface area of the fingerprint to be read. The reading is done when the sensor and the finger are in contact and in a relative motion of sliding of the sensor and the finger are respect to each other. The system reconstructs a complete image of the fingerprint from the partial images given by the sensor during this motion.	AR	OEB	13-Jun-97	97401345.0	26-Mar-03	0816184/E235718	Granted
		BE	OEB	13-Jun-97	97401345.0	26-Mar-03	813.154	Granted
		BR	BN	18-Jun-97	PI 9703596-8	26-Mar-03		Abandoned
		CA	BN	8-Jun-97	24205.825	20-Sep-05	2205.825	Granted
		CH	OEB	13-Jun-97	97401345.0	26-Mar-03	813.154	Granted
		CL	BN	13-Jun-97	1159-97	5-Nov-02	41.732	Granted
		CO	BN	16-Jun-97	9712390.X	28-May-03	9712390.X	Granted
		DE	BN	13-Jun-97	97032.825	13-Mar-03	97032.825	Granted
		ES	OEB	13-Jun-97	97401345.0	26-Mar-03	97401345.0	Granted
		FR	OEB	13-Jun-97	97401345.0	26-Mar-03	0816184/E235718	Granted
		GB	BN	14-Jun-96	9607.418	11-Sep-98	9607.418	Granted
		IL	OEB	13-Jun-97	97401345.0	26-Mar-03	813.154	Granted
		IN	BN	8-Jun-97	121.045	12-May-02	121.045	Granted
		IT	OEB	13-Jun-97	1659/OEL/1997			Pending
		JP	BN	13-Jun-97	97401345.0	26-Mar-03	813.154	Granted
		KR	BN	13-Jun-97	124174/97			Pending
		MX	BN	13-Jun-97	974.373	7-Mar-07	974.373	Granted
		NL	OEB	13-Jun-97	97401345.0	26-Mar-03	220.769	Granted
		SE	OEB	13-Jun-97	97401345.0	26-Mar-03	813.154	Granted
		US	BN	13-Jun-97	08/878.965	28-Mar-03	97401345.0	Granted
		US	BN	13-Jun-97	08/878.965	1-Oct-02	6,455,804	Granted
		VE	BN	11-Jun-97	111197	27-Nov-01	6,289,114	Granted
		ZA	BN	12-Jun-97	975.153	25-Mar-98	975.153	Granted

Updated: July 28, 2008

PATENT LIST-TRANSFER
Ameti Switzerland

Exhibit A

No.	Case No.	Title	Country	Type	Filing date	Filing number	Grant date	Grant number	Status
2	82806	METHOD OF PROVIDING A DIGITAL FINGERPRINT SENSOR AND THE CORRESPONDING SENSOR	DE	ECT	2-May-03	03749916.7	29-Dec-05	B03 03 037.8 03	Granted
		ABSTRACT: An embodiment of the present invention related to fingerprint sensor is described. The sensor comprises an integrated circuit chip having a sensitive surface, a substrate provided with electrical connections and wire bonding wires connecting the chip to the electrical connections. The sensor further includes a molded protective resin at least partly covering the substrate and the chip and completely encapsulating the wire bonding wires. The resin is at least 500 microns above the sensitive surface. The bump encapsulating the wire bonding wires and constituting a guide force finger the fingerprint, which is a dielectric defect.	FR	BN	2-May-03	03749916.7	29-Dec-05	205,732	Granted
			EP	ECT	2-May-03	03749916.7	29-Dec-05	1,512,114	Granted
			GB	ECT	2-May-03	03749916.7	29-Dec-05	1,512,114	Granted
			IT	ECT	2-May-03	03749916.7	29-Dec-05	1,512,114	Granted
			JP	PCT	2-May-03	2004-504178	28-Dec-05	1,512,114	Granted
			KR	PCT	2-May-03	2004-701751B			Pending
			NL	ECT	2-May-03	03749916.7	29-Dec-05	1,512,114	Granted
			US	PCT	2-May-03	10/519 308	1-Jul-08	7,893,711	Granted
			US	CON	30-Jul-03	12/166,829			Pending
			(Cont)						
			AUS		2-May-03	AU200300024589			Abandoned
3	21988-005001	SENSOR MANUFACTURE WITH DATA STORAGE	US	Pat	06-Mar-2007	11/982,583	8/10/2008	7885381	Granted
		ABSTRACT: A biometric sensing device includes a sensor manufacturing for sensing a biometric attribute. The sensor manufacturing is also configured to permanently store data electronically, such as security data.							

Updated July 08, 2008

PATENT LIST-TRANSFER
 Ahmed Switzerland

Exhibits

No. Case No.	Title	Country	Type	Filing date	Filing number	Grant date	Grant number	Status
4. 34	DEVICE AND METHOD OF RECOGNIZING AT LEAST ONE INDIVIDUAL, of at least one individual and to the corresponding access control device and one-piece integrated circuit which is produced by integrating the following elements on a silicon substrate: at least one biomorphic information sensor, means of processing said biomorphic information; cryptographic means, which deliver at least one piece of encrypted data, that is representative of at least one part of said biomorphic information and/or a corresponding piece of biometric information; and protection means that block access to data in memory, stored and/or processed in said one-piece integrated circuit in order to process said biomorphic information, means, and particularly the integrated circuit and cannot be accessed from outside. Moreover, any encrypted data are delivered to the outside from said one-piece integrated circuit.	FR	PI	8/14/2003	FR20070010892	3/19/2004	FR2828756	Granted
		EP	PC	8/13/2002	02 774974.8			Pending
		US	PT	8/13/2002	10/065,103	9/14/2007	7,265,263	Granted
		CA	PC	8/13/2002	2,457,017			Pending
		JP	PC	8/13/2002	2003-522043			Pending

Updated: July 29, 2008